

1.6X0.8mm SMD CHIP LED LAMP (0.25mm Height)



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE DEVICES

Part Number: APG1608QBC/G Blue

Features

- 1.6mmX0.8mm SMT LED, 0.25mm thickness.
- Low power consumption.
- Wide viewing angle.
- Compatible with automatic placement equipment.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

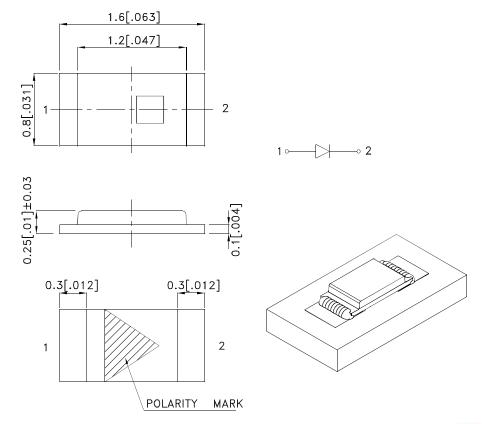
Descriptions

- The Blue source color devices are made with InGaN Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

Applications

1. Mobile phone Keypad indicator and backlight. 2.Flat backlight for LCD, switch and symbol. 3.Toys.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

SPEC NO: DSAJ8710 **REV NO: V.6B** DATE: MAY/06/2015 PAGE: 1 OF 5 APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Q.M.Chen ERP: 1203010213



Selection Guide

Part No.	Part No. Dice Lens Type		lv (mo @ 20	,	Viewing Angle [1]
		2.	Min.	Тур.	201/2
APG1608QBC/G	Blue (InGaN)	Water Clear	80	200	120°

Notes:

- 1. 01 / 2 is the angle from optical centerline where the luminous intensity is 1 / 2 of the optical peak value.
 2. Luminous intensity / luminous Flux: + / -15%.
 3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue	461		nm	IF=20mA
λD [1]	Dominant Wavelength	Blue	465		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Blue	25		nm	IF=20mA
С	Capacitance	Blue	100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Blue	3.3	4	V	IF=20mA
lR	Reverse Current	Blue		50	uA	V _R =5V

- Wavelength: + / -1nm.
 Forward Voltage: + / -0.1V.
- 2. Forward voltage. Fr -0.1V.
 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

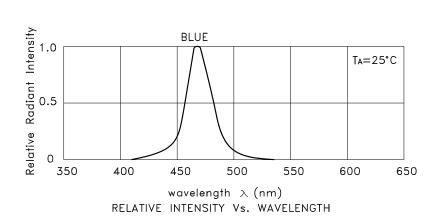
Absolute Maximum Ratings at TA=25°C

Parameter	Blue	Units	
Power dissipation	120	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Electrostatic Discharge Threshold (HBM)	250	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	ge Temperature -40°C To +85°C		

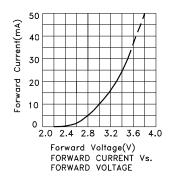
1. 1 / 10 Duty Cycle, 0.1ms Pulse Width.

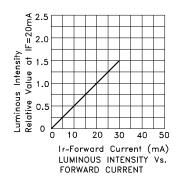
SPEC NO: DSAJ8710 **REV NO: V.6B** DATE: MAY/06/2015 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Q.M.Chen ERP: 1203010213

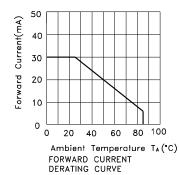
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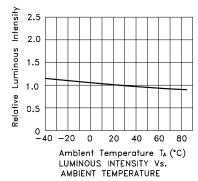


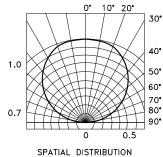
Blue APG1608QBC/G











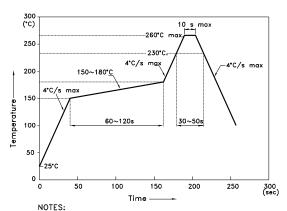
SPEC NO: DSAJ8710 REV NO: V.6B DATE: MAY/06/2015 PAGE: 3 OF 5
APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Q.M.Chen ERP: 1203010213

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APG1608QBC/G

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



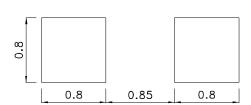
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

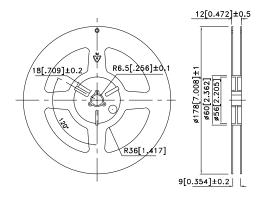
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

 3.Number of reflow process shall be 2 times or less.

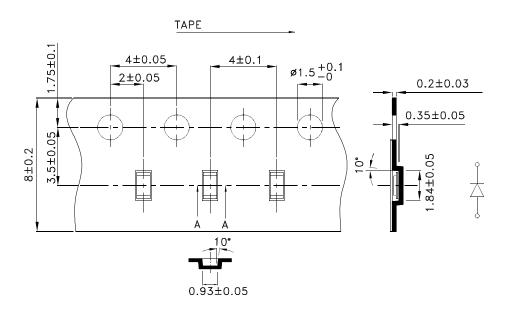
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



Tape Dimensions (Units: mm)

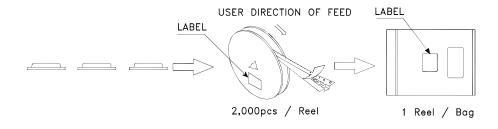


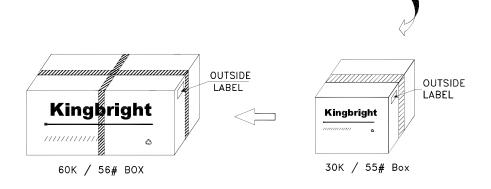
SPEC NO: DSAJ8710 **REV NO: V.6B** DATE: MAY/06/2015 PAGE: 4 OF 5 **APPROVED: WYNEC CHECKED: Allen Liu** DRAWN: Q.M.Chen ERP: 1203010213

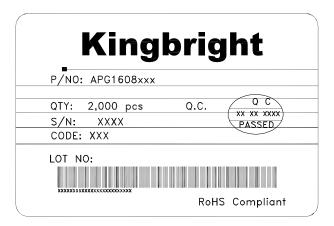
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PACKING & LABEL SPECIFICATIONS

APG1608QBC/G







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 SPEC NO: DSAJ8710
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 PAGE: 5 OF 5

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